

IoT OPTIMIZED LOW PROFILE QUARTZ CRYSTAL



3.2 x 2.5 x 0.75mm

 RoHS/RoHS II Compliant

MSL = N/A: NOT APPLICABLE

ABM8W SERIES

FEATURES

- Optimized for energy saving wearables and IoT applications
- Plated at exceptionally low plating capacitance, as low as 4pF, with optimized ESR
- 0.75 mm max height ideally suited for height constrained designs
- Seam sealed for longterm reliability

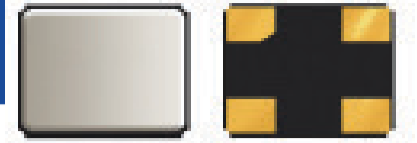
APPLICATIONS

- Wearables
- Internet of Things (IoT)
- Bluetooth/Bluetooth Low Energy (BLE)
- Wireless modules
- Machine-to-machine (M2M) connectivity
- Ultra-low power MCU
- Near Field Communication (NFC)
- ISM Band

STANDARD SPECIFICATIONS

Parameters	Minimum	Typical	Maximum	Units	Notes
Frequency Range	10.0000		54.0000	MHz	
Operation Mode	Fundamental				
Operating Temperature Range	-40		+125	°C	See options
Storage Temperature	-55		+125	°C	
Frequency Tolerance @ +25°C	-10		+10	ppm	See options
Frequency Stability over the Operating Temperature (ref. to +25°C)	-10		+10	ppm	See options
Equivalent series resistance (R1) (over -40°C to +125°C)		< 100	200	Ω	10.0000 – 11.9999MHz
		< 60	100		12.0000 – 15.9999MHz
		< 40	70		16.0000 – 19.9999MHz
		< 25	50		20.0000 – 29.9999MHz
		< 20	40		30.0000 – 39.9999MHz
		< 18	30		40.0000 – 54.0000MHz
Shunt capacitance (C0)		< 1.2	2.0	pF	
Load capacitance (CL)		4.0		pF	See options
Drive Level		10	100	μW	
Aging (1 year)	-2		+2	ppm	@ 25°C±3°C
Insulation Resistance	500			MΩ	@ 100Vdc ± 15V

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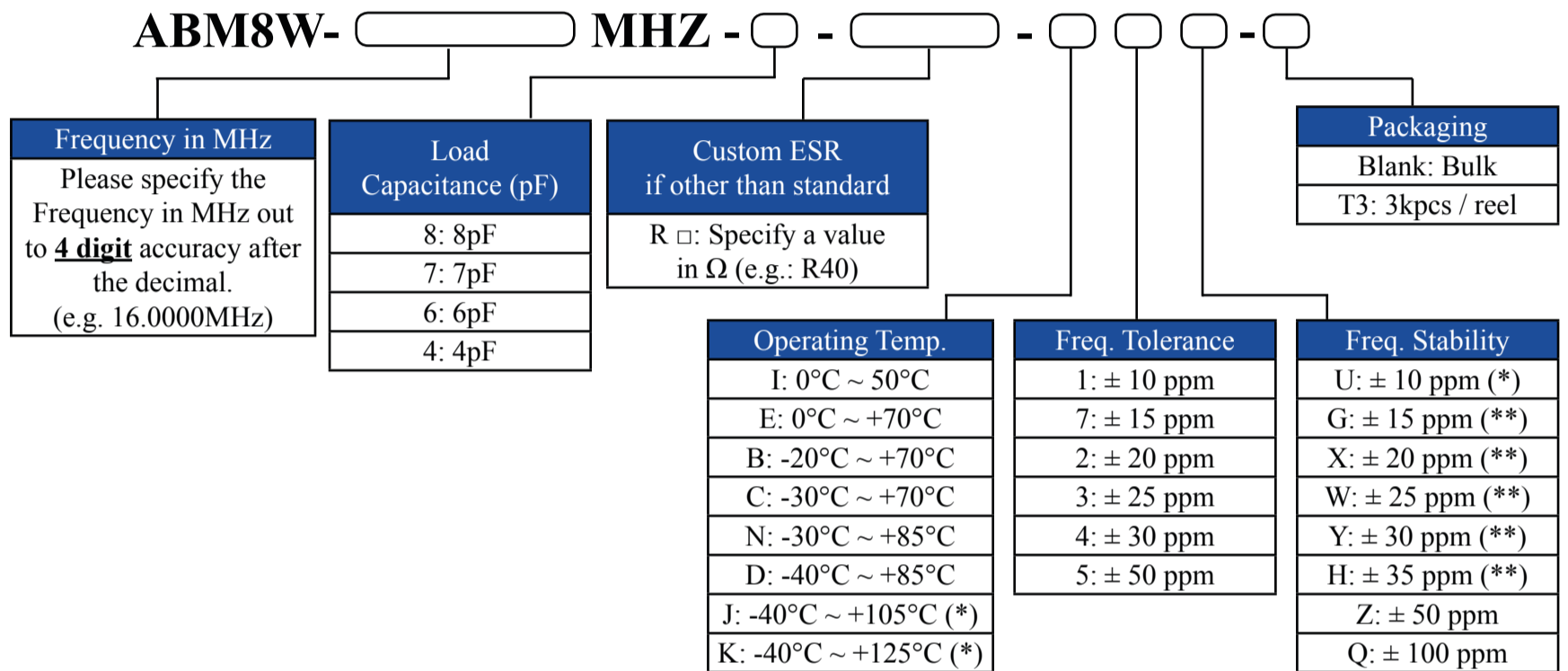
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OPTIONS AND PART IDENTIFICATION (NOTE 1)

Note 1: Contact Abracon for part number requests with carrier frequency callouts up to 5&6 digit accuracy after the decimal.



(*) Only offered @ Freq. Stability options: Z & Q.

Contact ABRACON for tighter Frequency Stability.

(*) Only offered @ Operating Temp. Range options: I, E, & B

(**) Only offered @ Operating Temp. Range options: I, E, B, C, N, & D

Contact ABRACON for wider Operating Temp. Range.

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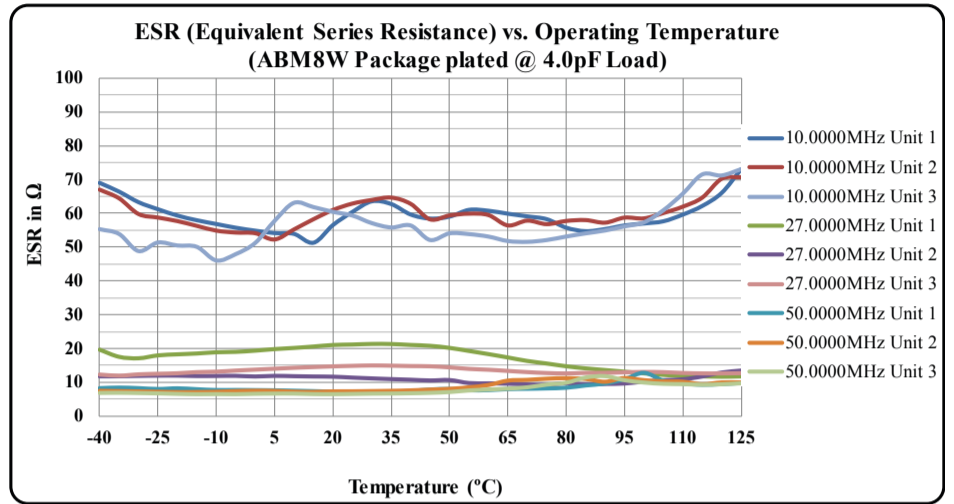
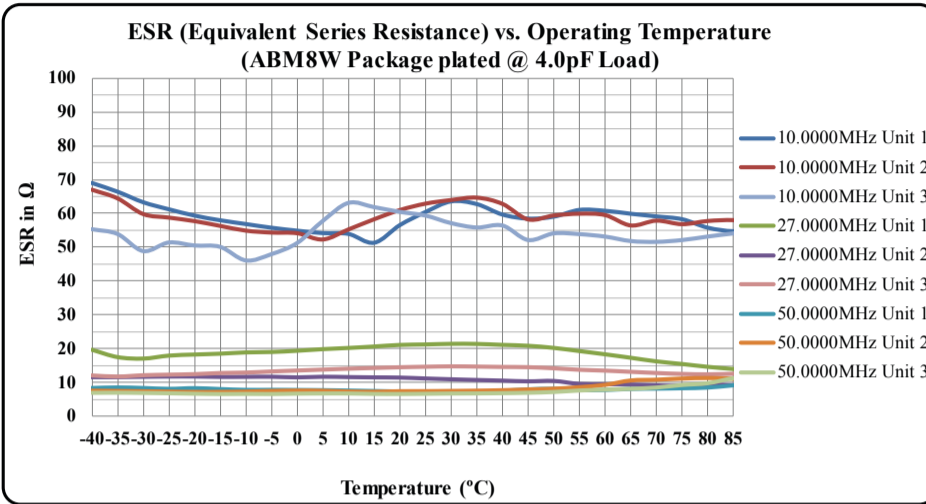
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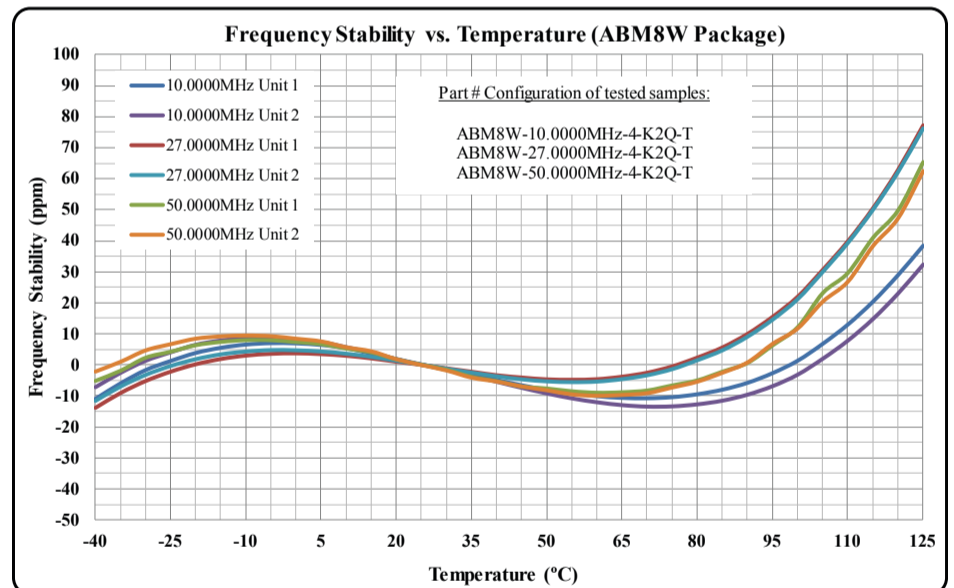
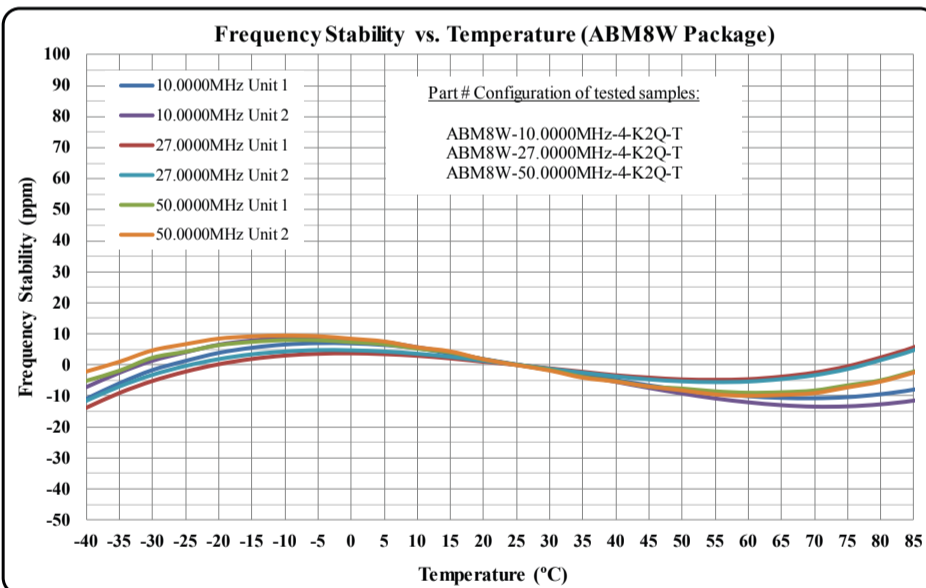
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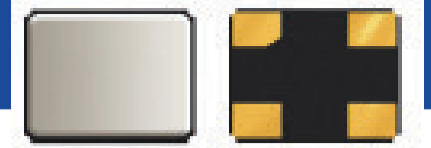
TYPICAL ESR (EQUIVALENT SERIES RESISTANCE) Vs. TEMPERATURE CHARACTERISTICS



TYPICAL FREQUENCY Vs. TEMPERATURE CHARACTERISTICS



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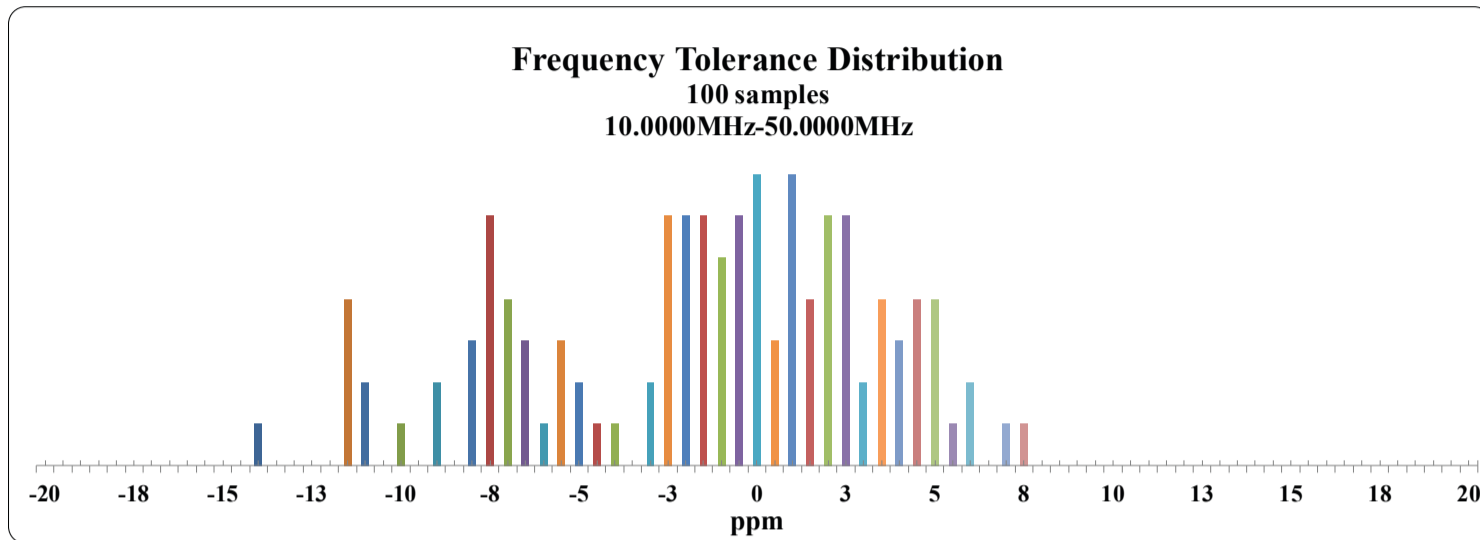
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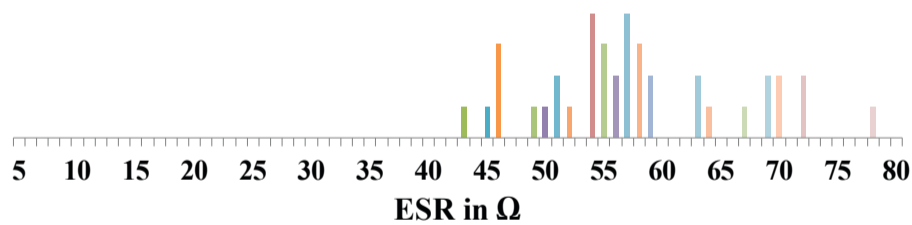
TYPICAL FREQUENCY TOLERANCE DISTRIBUTION (AT 25°C ± 3°C)



TYPICAL ESR DISTRIBUTION (AT 25°C ± 3°C)

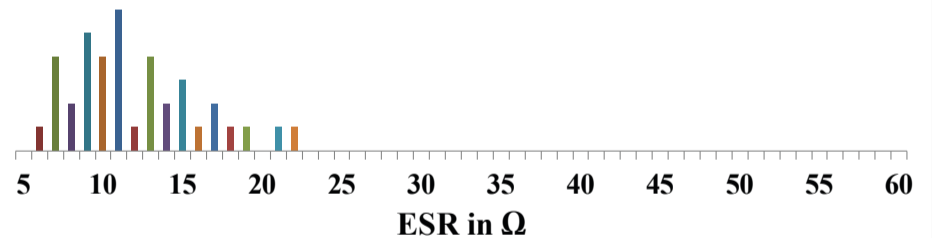
ESR Distribution @ 10.0000MHz

100 samples
MAX ESR = 77.7 Ω



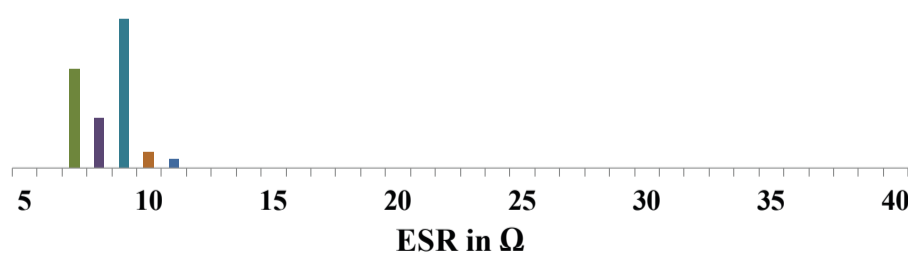
ESR Distribution @ 27.0000MHz

100 samples
MAX ESR = 21.6 Ω

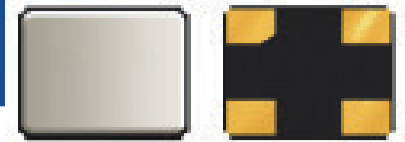


ESR Distribution @ 50.0000MHz

100 samples
MAX ESR = 10.23 Ω



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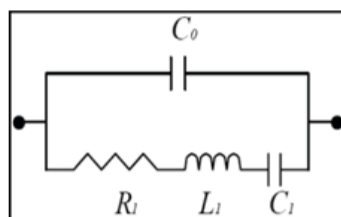
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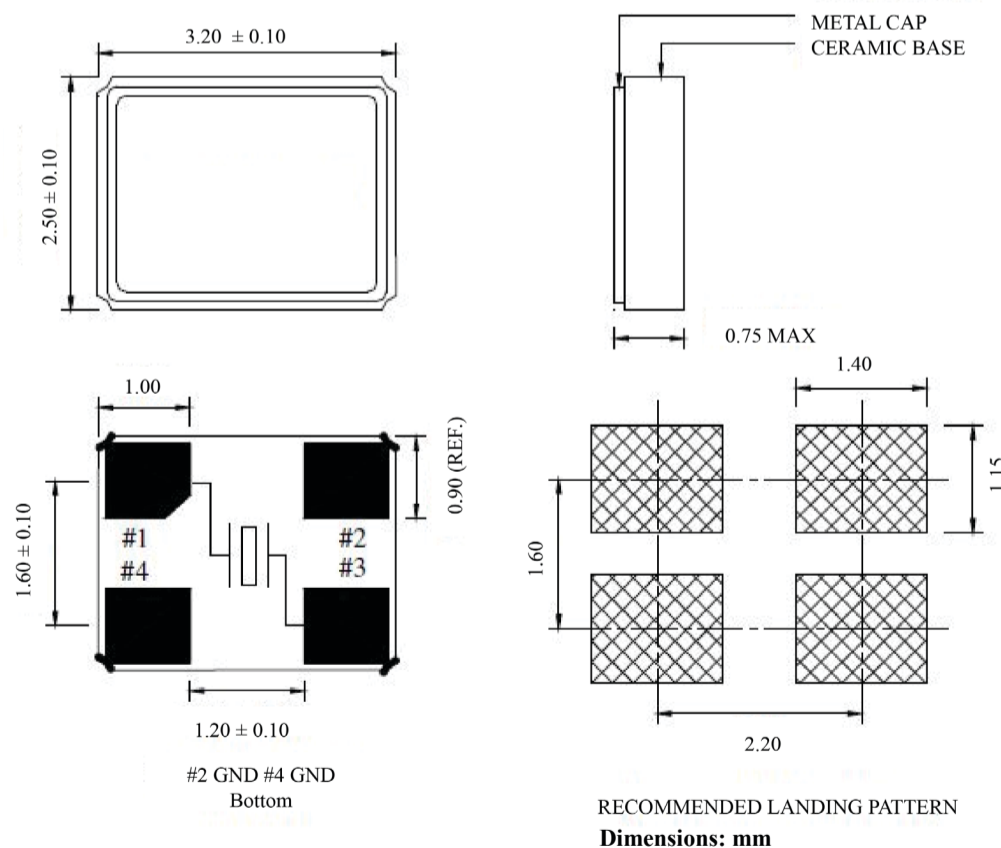
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SPICE MODELS (BASED ON TYPICAL VALUES AT 25°C ± 3°C)



Frequency: 10.0000MHz Plating Load: 4pF			Frequency: 10.0000MHz Plating Load: 6pF		
C0	=	0.88 pF	C0	=	0.86 pF
R1	=	53.82 Ω	R1	=	60.62 Ω
L1	=	162.02 mH	L1	=	164.96 mH
C1	=	1.56 fF	C1	=	1.54 fF
Frequency: 27.0000MHz Plating Load: 4pF			Frequency: 27.0000MHz Plating Load: 6pF		
C0	=	1.16 pF	C0	=	1.16 pF
R1	=	11.83 Ω	R1	=	11.06 Ω
L1	=	9.16 mH	L1	=	9.10 mH
C1	=	3.80 fF	C1	=	3.82 fF
Frequency: 50.0000MHz Plating Load: 4pF			Frequency: 50.0000MHz Plating Load: 6pF		
C0	=	1.16 pF	C0	=	1.15 pF
R1	=	7.61 Ω	R1	=	8.06 Ω
L1	=	2.45 mH	L1	=	2.49 mH
C1	=	4.14 fF	C1	=	4.07 fF

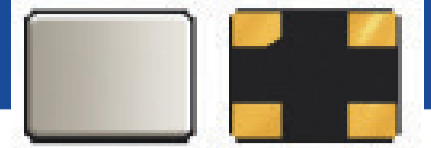
MECHANICAL DIMENSIONS



Note:

Due to material availability the Chamfer could be located on pin #1, 2 or 4. Be advised that the Chamfer location has no impact on the electrical performance of the device.

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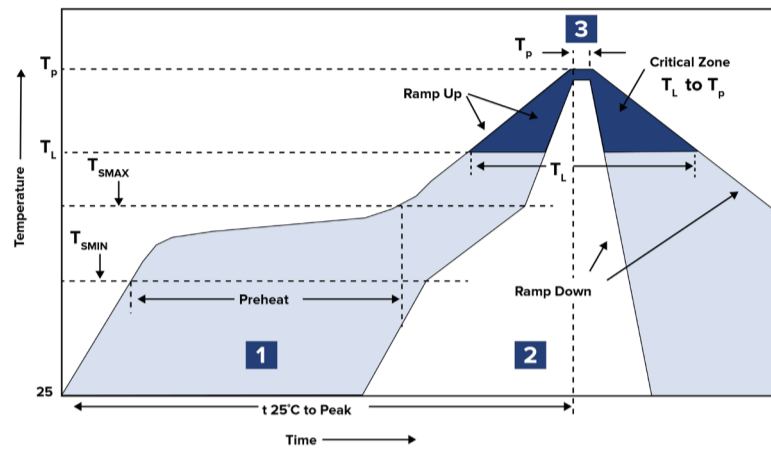
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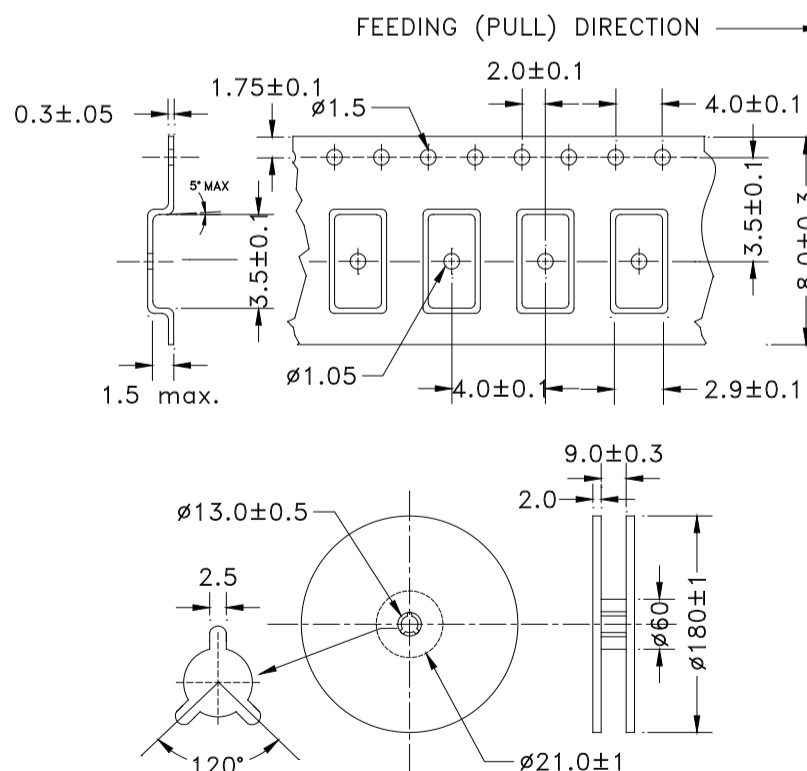
REFLOW PROFILE



Zone	Description	Temperature	Time
1	Preheat	$T_{SMIN} \sim T_{SMAX}$ 150°C ~ 180°C	60 ~ 120 sec.
2	Reflow	T_L 217°C	45 ~ 90 sec.
3	Peak Heat	T_P 260°C MAX	10 sec.

PACKAGING

T3: Tape and reel (3,000 pcs/reel)



DIMENSIONS: mm



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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